



**PATENT** 

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June 27 2001

Chenyl Ammerlahn

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jason B. Elledge

Attorney Docket No.: 500188.03

Serial No. : 09/833,029

: April 10, 2001

Group Art Unit : 3723

Filed Title Examiner

: Not yet assigned

: APPARATUS FOR IN-SITU OPTICAL ENDPOINTING ON WEB-FORMAT

PLANARIZING MACHINES IN MECHANICAL OR CHEMICAL-MECHANICAL PLANARIZATION OF MICROELECTRONIC-DEVICE SUBSTRATE ASSEMBLIES

AND METHODS FOR MAKING AND USING SAME

## SUPPLEMENTAL PRELIMINARY AMENDMENT

Box Missing Parts Commissioner of Patents Washington, D.C. 20231

Sir:

Please amend the above-identified application as follows:

In the Claims:

Please add claims 46-64 below.

46. (New) The polishing pad of claim 1, further comprising:

an optically transmissive backing sheet having a top surface and a under surface, the planarizing medium being disposed on the top surface;

a backing pad attached to the under surface of the backing sheet; and